





## Certificate of Registration

BUSINESS CONTINUITY MANAGEMENT SYSTEM - ISO/IEC 22301:2019

This is to certify that:

Advanced Semiconductor Engineering, Inc.(K1)

No.26, Jing 3rd Rd.

Nanzi Dist. Kaohsiung City

811641

Taiwan (R.O.C.)

Holds Certificate No:

**BCMS 704809** 

and operates a Business Continuity Management System which complies with the requirements of ISO 22301:2019 for the following scope:

The business continuity management system in relation to the provision of bumping, wire bonding, flip chip and testing of integrated circuit (IC) and related supporting activities within K1, K2, K3, K5, K7, K8, K11, K12, K21, K22, K24 and K25.

For and on behalf of BSI:

Michael Lam - Managing Director Assurance, APAC

Original Registration Date: 2019-04-21 Latest Revision Date: 2024-03-20 Effective Date: 2022-04-21 Expiry Date: 2025-04-20



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...making excellence a habit."

This certificate was issued electronically and remains the property of BSI and is bound by the conditions of contract. An electronic certificate can be authenticated online.

Printed copies can be validated at www.bsi-global.com/ClientDirectory or telephone +886 (02)2656-0333. Taiwan Headquarters: 2nd Floor, No.37, Ji-Hu Rd., Nei-Hu Dist., Taipei 114, Taiwan, R.O.C. A Member of the BSI Group of Companies.

Certificate No:

**BCMS 704809** 

Registered Activities

Location Advanced Semiconductor Engineering, Inc.(K1) The business continuity management system in relation to the provision of wire bonding of No.26, Jing 3rd Rd. integrated circuit (IC). Nanzi Dist. Kaohsiung City 811641 Taiwan (R.O.C.) Advanced Semiconductor Engineering, Inc.(K7) The business continuity management system in relation to the provision of bumping, wire No. 109, Neihuan N. Rd. Nanzi Dist. bonding and testing of integrated circuit (IC). Kaohsiung City 811620 Taiwan (R.O.C.) The business continuity management system in Advanced Semiconductor Engineering, Inc.(K2) No. 25, Kaifa Rd. relation to the provision of wire bonding of integrated circuit (IC). Nanzi Dist. Kaohsiung City 811638 Taiwan (R.O.C.) Advanced Semiconductor Engineering, Inc.(K3) The business continuity management system in relation to the provision of wire bonding of No.47, Kaifa Rd. integrated circuit (IC). Nanzi Dist. Kaohsiung City 811638 Taiwan (R.O.C.) The business continuity management system in Advanced Semiconductor Engineering, Inc.(K5) relation to the provision of bumping and No. 66, Jing 6th Rd. wirebonding of integrated circuit (IC). Nanzi Dist. Kaohsiung City

Taiwan (R.O.C.)

811649

Original Registration Date: 2019-04-21 Latest Revision Date: 2024-03-20

Effective Date: 2022-04-21 Expiry Date: 2025-04-20

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Taiwan Headquarters: 2nd Floor, No.37, Ji-Hu Rd., Nei-Hu Dist., Taipei 114, Taiwan, R.O.C.

A Member of the BSI Group of Companies.

Certificate No:

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Location	Registered Activities
Advanced Semiconductor Engineering, Inc.(K11) No.30, Zhongyang Rd. Nanzi Dist. Kaohsiung City 811617 Taiwan (R.O.C.)	The business continuity management system in relation to the provision of flip chip of integrated circuit (IC).
Advanced Semiconductor Engineering, Inc. (K21) No. 2, Chuangyi S. Rd. Nanzi Dist. Kaohsiung City 811646 Taiwan (R.O.C.)	The business continuity management system in relation to the provision of bumping, flip chip and testing of integrated circuit (IC).
Advanced Semiconductor Engineering, Inc. (K22) No. 1, Chuangyi N. Rd. Nanzi Dist. Kaohsiung City 811648 Taiwan (R.O.C.)	The business continuity management system in relation to the provision of bumping, flip chip and testing of integrated circuit (IC).
Advanced Semiconductor Engineering, Inc. (K8) No. 10, W. 5th St. Nanzi Dist. Kaohsiung City 811627 Taiwan (R.O.C.)	The business continuity management system in relation to the provision of testing of integrated circuit (IC).
Advanced Semiconductor Engineering, Inc. (K24) No. 1, Chuangyi S. Rd. Nanzi Dist. Kaohsiung City 811646 Taiwan (R.O.C.)	The business continuity management system in relation to the provision of wire bonding of integrated circuit (IC).

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Certificate No:

**BCMS 704809** 

Location

Registered Activities

Advanced Semiconductor Engineering, Inc. (K25)

No. 2, Keji Rd. Nanzi Dist. Kaohsiung City

Kaohsiung City 811651

Taiwan (R.O.C.)

The business continuity management system in relation to the provision of wire bonding, Flip chip and Testing of integrated circuit (IC).

Advanced Semiconductor Engineering, Inc. (K12)

No. 115, Neihuan N. Rd.

Nanzi Dist. Kaohsiung City 811620

Taiwan (R.O.C.)

The business continuity management system in relation to the provision of bumping, flip chip and testing of integrated circuit (IC).

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